

# PRIMERGY RX300 S7

# System configurator and order-information guide

## **April 2014**

## **Contents**



## Instructions

Configuration diagram

## Configurator

- 0 System software
- I Basic unit
- II Processor
- III Memory
- **IV** Graphics
- V Accessible drives
- VI Hard disk drives
- VII PCI Controller
- VIII Communication/Network
- IX System Management Products (RemoteView)
- X Miscellaneous
- XI Country specific power cord

## Change report



## Instructions

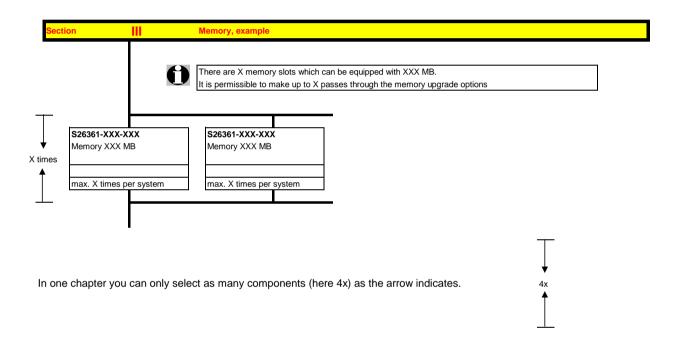
This document contains basic product and configuration information that will enable you to configure your system via PC-/System-Architect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



Please note that there are information symbols which indicate necessary information.



For further information see:

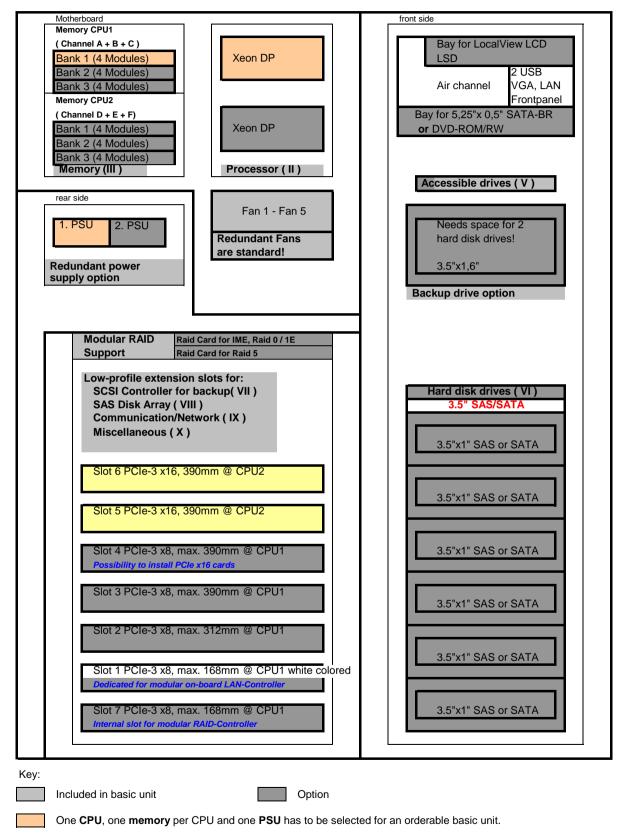
http://ts.fujitsu.com/products/standard\_servers/inc (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy\_config/current/Pages/default.aspx (extranet)

## Configuration diagram PRIMERGY RX300 S7

System unit (I)

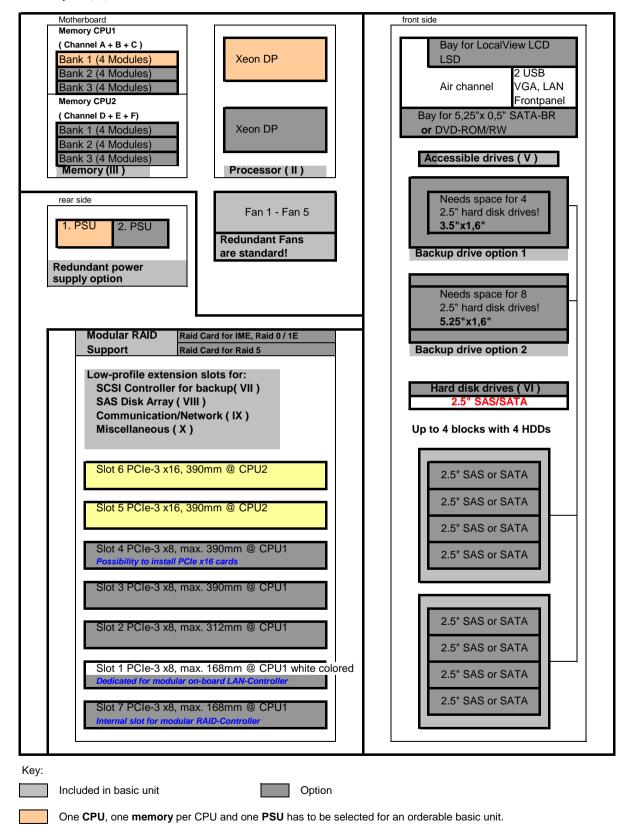
with up to 6x 3.5" Hard disk drives

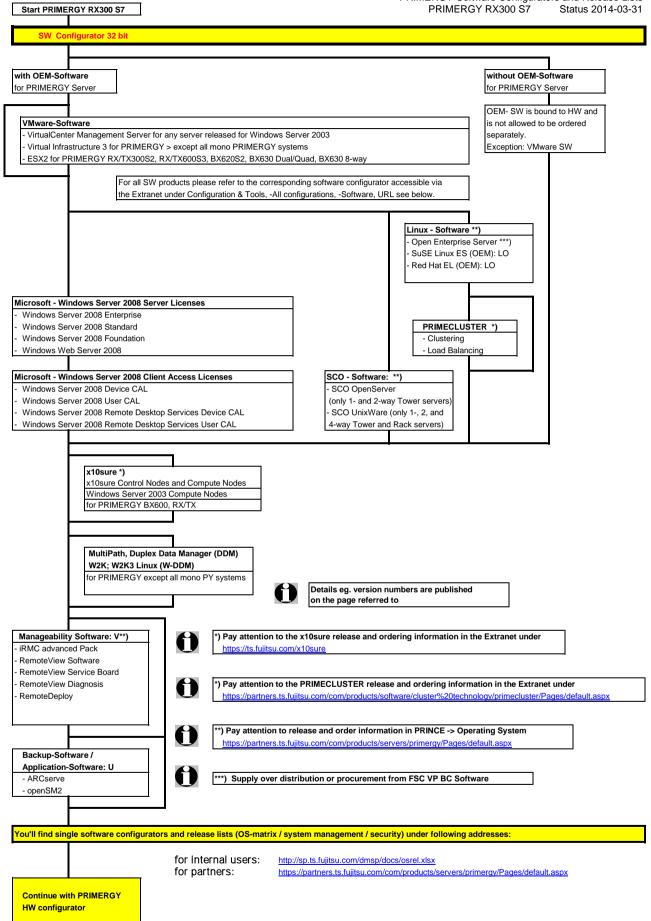


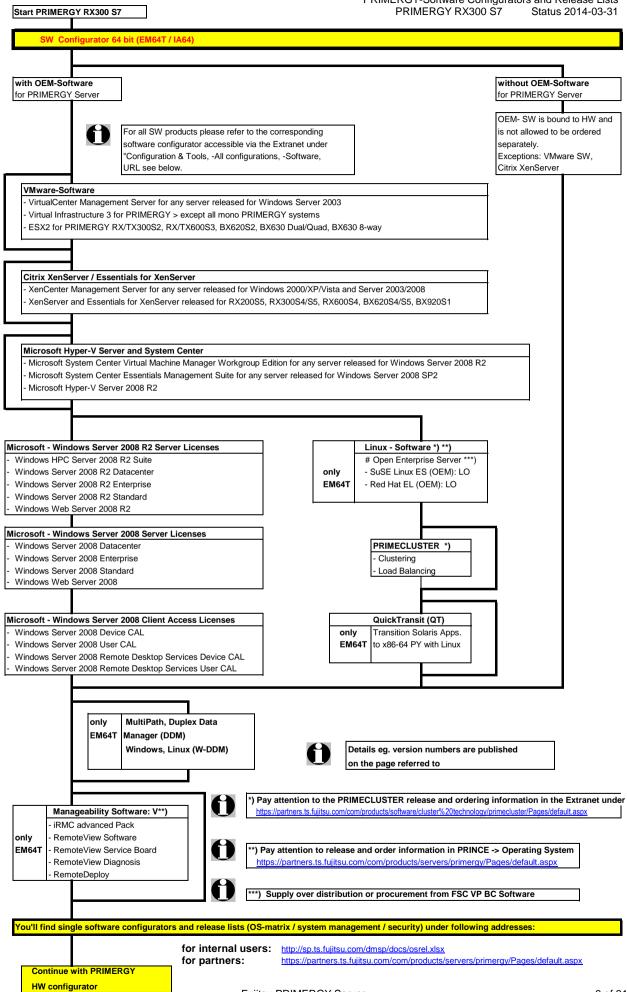
## Configuration diagram PRIMERGY RX300 S7

System unit (I)

with up to 4, 8, 12 or 16x 2.5" Hard disk drives







Section

Basic unit



System unit consisting of:

- \* 2U Housing without power supply modules
- Basic units with:
- 2 Hot-Plug Power Supply Bays
- 5 Fans (full redundancy)
- \* SAS Backplane for 6x 3.5" HD or SAS Backplanes for 4, 8, 12 or 16x 2.5" HD with cable connection to on-board or modular RAID Controller

#### \* Drives/Bays

- 6 bays 1" for hot plug 3.5" HD (1" high) or 4, 8, 12 or 16 bays for hot plug 2.5" HD
- 1 bay for 3.5" and 1.6" high Backup device, consumes 2 bays for 3.5" HD for basic unit 6x 3.5" HD not possible for basic unit with 12 or  $16 \times 2.5$ " HD
- 1 bay for 5.25" and 1.6" high Backup device, not possible for basic unit 6x 3.5" HD for basic unit with 12 or 16 x 2,5" HD
- 1 bay SATA-CD- or DVD-ROM 0,5" height (option)
- 1 bay for opt. LocalView LC-Display
- \* Integrated ServerView Diagnostics Technology ( Diagnosis LED's ) for indication of internal failed components

#### Systemboard D2939 with:

\* Up to two Xeon 4C, 6C & 8C CPU's (Socket-R)

with 2 serial QPI links ( Quick Path Interconnect ) and four memory channels per CPU First CPU has to be selected for an orderable basic unit,

Chipset Intel® C600 Series (codenamed Patsburg)

7 PCI slots:

- 2x PCle-3 x16 (both slots are connected to CPU 2 and are useable with configured 2nd CPU only!)
- 4x PCle-3 x8 (one notched to install x16 cards)
- 1x PCIe-3 x8 (for internal modular RAID controller only)
- \* 24 memory slots for max. 768GB RAM DDR3 available
- Memory is divided into 12 DIMMs per CPU ( 4 channels with 3 slots per channel )

Possible max. configurations are:

24x 32GB LRDIMM (quad rank modules) = 768GB

24x 16GB RDIMM (dual rank modules) = 384GB

16x 8GB UDIMM (dual rank modules) = 128GB

First Memory ( one module ) has to be selected for an orderable basic unit per CPU

- Memory upgrade is possible module wise
- Memory mirrroring is supported with 2 identical modules in channel A+B CPU 1 or D+E CPU 2
- Hot Spare Memory is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2
- SDDC (Chipkill) is supported for memory modules,
- Dual Port 10/100/1000 x4 PCI Express\* Gigabit Ethernet Intel LAN controller Powerville on-board
- iRMC S3 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100/1000 Service LAN-port and integrated graphics controller.

The Service LAN-port can be switched alternatively on standard Gbit LAN port 1

\* Graphics Controller integrated in iRMC S3 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz

(1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

## Interfaces at the rear:

- \* 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- \* 1x VGA (15 pins)
- \* 4x USB 2.0 ( UHCI ) with 480MBit/s, no USB wakeup
- \* 2x LAN RJ45, 1x Service-LAN RJ45

#### Interfaces on the front:

- \* 2x USB **2.0** ( UHCI ) with **480MBit/s,** no USB wakeup
- \* 1x VGA (15 pins) as an option
- \* 1x Service-LAN RJ45 as an option

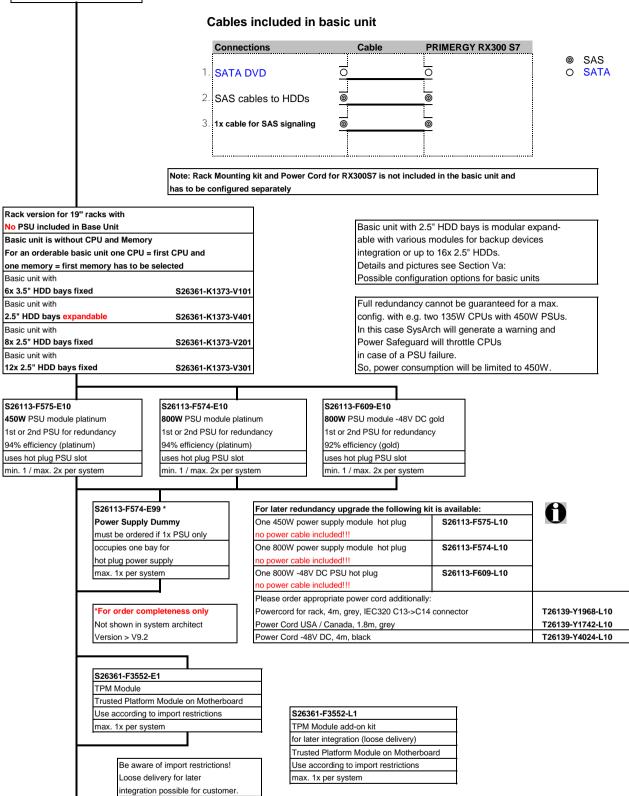
#### Interfaces internal:

- \* 1x released internal USB Interfaces for backup devices,
- \* 1x USB 2.0 (UHCI) with 480MBit/s for dongle funcionality (uSSD memory), no USB wakeup
- \* 1x SATA interface for DVD (only usable with 4x 2.5" HDD + DVD Option)
- \* 4x SATA/SAS interface for 4 SATA/SAS HD`s or SAS Backup device
- \* 2x USB 2.0 ports for internal USB redirection connected to BMC

#### Software

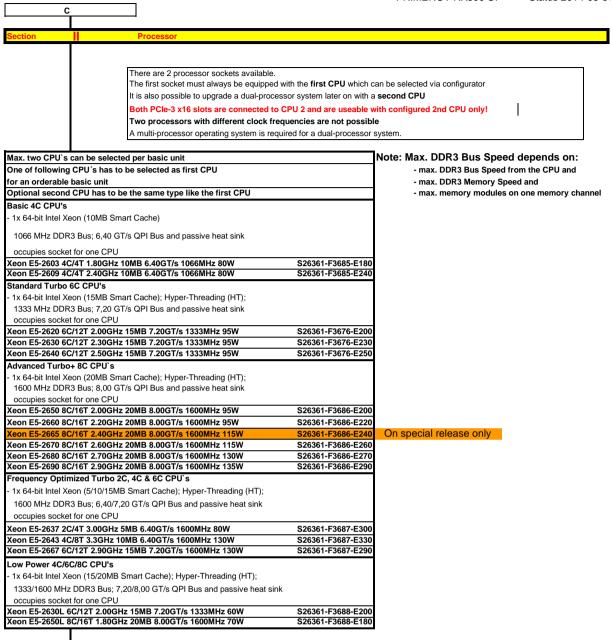
- \* ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
- \* Documentation engl. (multilingual on CD)

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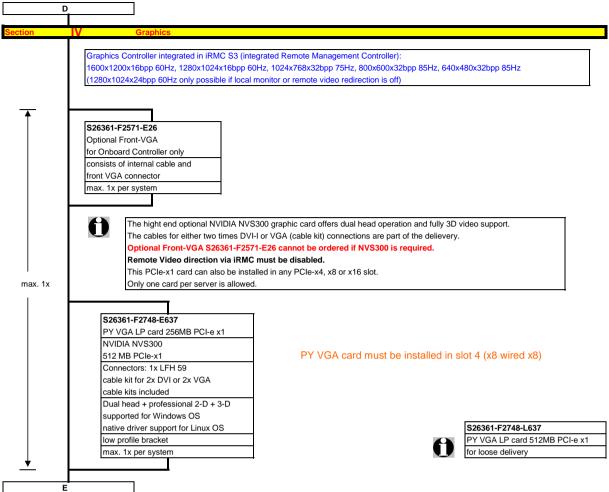


В

С



D



E

Section III Memo



#### - There are 12 memory slots per CPU for max.

384GB LRDIMM (12x 32GB 4R) 192GB RDIMM (12x 16GB 2R)

32GB UDIMM (8x 4GB)

#### => max. 768GB for two CPU's ( 384GB per CPU ), using LRDIMM

- The memory area is divided into 4 channels per CPU with 3 slots per channel
- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2, slot 3 belongs to memory bank 3

#### Registered, LR DIMMs and unbuffered memory modules can be selected

#### No mix of registered, load reduced and unbuffered modules allowed.

Memory can be operated at 1.5V or 1.35V, even if the modules are of low voltage type.

Memory operating voltage can be set within BIOS (1.5V is default setting for max. speed).

In a 2 DIMMs per channel configuration, following frequencies are supported:

- 1.5V  $\,$  - 1600MHz max (depending on CPU, special memory modules)

- 1.35V - 1333MHz max (depending on CPU)

In a 3 DIMMs per channel configuration, memory will operate at 1.5V only.

SDDC (Chipkill) is supported for registered / load reducced x4 organized memory modules only

#### 1.) In the "Independent Channel Mode" is following configuration possible

Channels can be populated in any order in Independent Channel Mode. All four channels may be populated in any order and have no matching requirements. All channels must run at the same interface frequency but individual channels may run at different DIMM timings (RAS latency, CAS latency, and so forth)

No mix of registered, load reduced and unbuffered modules allowed.

#### 2.) "Rank Sparing Mode" configuration

- Within a memory channel, one rank is a spare of the other ranks.

The Spare Rank is held in reserve and is not available as system memory

For the effective memory capacity, please refer to the spreadsheet below.

The BIOS is set to the rank sparing setting.

Minimum configuration is: 2x 1R, 2x 2R or 1x4R DDR3 module per channel

This mode is not supported by unbuffered memory modules

#### 3.) "Performance Mode" configuration

- In this configuration, the memory module population ex factory is spread across all channels.

The BIOS is set to the  $\max$ , performance for memory.

Minimum configuration is: 4x identical modules

#### 4.) In the "Mirrored Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 4x registered or load reduced or unbuffered DDR3 modules

In each memory bank channel A and B / C and D of CPU 1 or channel E and F / G and H of CPU 2 have to be equipped with identical modules for mirrored channel mode.

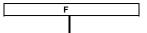
In channel B / D is always the mirrored memory of channel A / B of CPU 1

In channel F / H is always the mirrored memory of channel E / G of CPU 2  $\,$ 

Minimum configuration is: 4x identical modules

This mode is not supported by unbuffered memory modules

F



S26361-F3694-E10 Independent Mode

Independent Channel Mode allows all channels to be populated in any order. No specific Memory RAS features are defined

Requires min 1 memory Module per CPU

S26361-F3694-E1 Rank Sparing Mode Installation

BIOS Setup factory preinstalled to this mode. One Rank is spare of other ranks on the same channel. Spare Rank is not shown in System Memory. For effective capacity within a channel, please have a look below.

Supported for RDIMM / LRDIMM only.

1x per CPU Requires min 2x 1R/2R or 1x 4R modules per CPU

S26361-F3694-E2 Performance Mode Installation

BIOS Setup factory preinstalled for max. Performance, LV memory might be set to 1.5V operation. Four identical memory modules will be equipped in one memory bank to achieve highest memory performance. All four modules are active and full capacity can be used.

Multiple of 4 identical modules to be configured per CPU

S26361-F3694-E3 Mirrored Channel Mode Installation

BIOS Setup factory preinstalled to this mode. Four identical memory modules are always equipped in one memory bank to use the

Mirrored channel Mode. Only two modules contain active data, the remain two modules contain mirrored data

Supported for RDIMM / LRDIMM only.

Multiple of 4 identical modules to be configured per CPU



Effe	Effective Memory capacity / Rank Sparing Mode, 1 Channel populated										
	UD	IMM		RDIMM	LRDIMM						
	2GB 1R	2GB 2R	4GB 1R	8GB 2R	16GB 2R	16GB 4R	32GB 4R				
1DPC	na	na	na	na	na	12GB	24GB				
2DPC	na	na	4GB	4GB 12GB 24GB 28G		28GB	56GB				
3DPC	na	na	8GB	20GB	40GB	40GB	80GB				



#### Minimum one memory module or order code per CPU = first memory

Unbuffered Memory (UDIMM) no SDDC (chipkill) support

one DDR3 unbuffered ECC mem. Module, 1.35V

Choose up to 8 order codes per CPU

Registered Memory (RDIMM) no SDDC (chipkill) support

- one DDR3 registered ECC mem. Module, 1.35V

No mix with any other types of memory modules possible Choose up to 12x for 1R/2R or 8x for 4R per CPU

For performance reasons, we do not recommend

to configure more than 8 DIMMs per CPU

4GB (1x4GB) 2Rx8 L DDR3-1600 R ECC

S26361-F3695-E514

Registered Memory (RDIMM) with SDDC (chipkill) support

one DDR3 registered ECC mem. Module, 1.35V I333MHz supported with up to 2DPC (8 modules/CPU)

Choose up to 12 order codes per CPU

 4GB (1x4GB) 1Rx4 L DDR3-1333 R ECC
 \$26361-F3696-E514

 8GB (1x8GB) 2Rx4 L DDR3-1333 R ECC
 \$26361-F3696-E515

Registered Memory (RDIMM) with SDDC (chipkill) support

one DDR3 registered ECC mem. Module, 1.35V

1600MHz supported with up to 2DPC (8 modules/CPU)

at 1.5V

8/12x per

CPU, max. 2/3 modules

per channel

Choose up to 12 order codes per CPU

 4GB (1x4GB) 1Rx4 L DDR3-1600 R ECC
 \$26361-F3697-E514

 8GB (1x8GB) 2Rx4 L DDR3-1600 R ECC
 \$26361-F3697-E515

 16GB (1x16GB) 2Rx4 L DDR3-1600 R ECC
 \$26361-F3697-E516

Load Reduced Memory (LRDIMM) with SDDC (chipkill) support

one DDR3 load reduced ECC mem. Module, 1.35V

 Choose up to 12 order codes per CPU

 16GB (1x16GB) 4Rx4 L DDR3-1333 LR ECC
 \$26361-F3698-E516

 32GB (1x32GB) 4Rx4 L DDR3-1333 LR ECC
 \$26361-F3698-E517

Mix of memory modules is only possible within the same group

Max. DDR3 memory speed depends on the memory configuration (No of mem modules per channe) as well as on the CPU type.

The memory channel with the lowest speed defines the speed

of all CPU channels in the system, also for the channels of the

please check the spreadsheet "Memory speed" below

For real memory speed (depending on memory type / population),

new due to supply new due to supply

second CPU if configured

## **Memory Configuration PRIMERGY RX300 S7**

Each CPU offers 12 Slots for DDR3 Memory Modules organised in 3 Banks and 4 Channels.

If you need more than 12 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 3 different kinds of DDR3 Memory Modules available: UDIMM / RDIMM and LRDIMM UDIMM / RDIMM / LRDIMM offer different functionality. Mix of UDIMM / RDIMM / LRDIMM is not alloved.

If 1.5V and 1.35V DIMMs are mixed, the DIMMs will run at 1.5V

Mode	Configuration	UDIMM	RDIMM	RDIMM	Application			
		ODIMIN	KDIIVIIVI	LRDIMM				
		х8	х8	x4				
SDDC (chipkill) support	any	no	no	yes	detect multi-bit errors			
Independant Channel Mode	1, 2 or 3 Modules per Bank	yes	yes	yes	offers max. flexibility, upgradeability, capacity use UDIMM modules for lowest cost			
Mirrored Channel Mode *)	4 identical Modules / Bank	no	no	yes	offers maximum security			
Performance Mode	4 identical Modules / Bank	yes	yes	yes	offers maximum performance and capacity			
Rank Sparing Mode *)	min. 2 Ranks / Channel	no	no	yes	balances security and capacity			

<sup>\*)</sup> For the delivery ex works the system will be prepared with dedicated BIOS setting.

Capacity	Configuration	UDIMM	RDIMM	LRDIMM	Notes
Min. Memory per CPU	1 Module / CPU	1x2GB	1x4GB	1x 16GB	with one CPU
Max. Memory per CPU	8/12 Modules / CPU	8x4GB	12x16GB	12x 32GB	with one CPU
Max. Memory per System	16/24 Modules / System	64GB	384GB	768GB	if second CPU is configured

#### **Memory-Speed:**

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU The memory channel with the lowest speed defines the speed of all CPU channels in the system

Mem. Speed provided by CPU		Real maximum memory-bus speed depending on CPU type, memory configuration (DPC) and voltage setting (BIOS)																
	UDIMM 1600MHz					RDIMM 1600MHz					LRDIMM 1333MHz							
Voltage setting (BIOS)		1.5V [default]		1.35V		1.5V [default]			1.35V			1.5V [default]			1.35V			
	1	2	3	1	2	3	1	2	3	1	2	3	1	2	3	1	2	3
	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC	DPC
CPU with 1600MHz DDR3 Bus	1333	1333	-	1066	1066	-	1600	1600	1066	1333	1333	-	1333	1333	1066	1066	1066	-
CFO WITH 1000IMI12 DDR3 Bus	1600	1555	-	1333	1000	-	1000	1000	1000	1333	1333	-	1555	1555	1000	1000	1000	-
CPU with 1333MHz DDR3 Bus	1333	1333	- ,	1066	1066	-	1333	1333	1066	1333	1333	-	1333	1333	1066	1066	1066	-
CPU with 1066MHz DDR3 Bus	1066	1066	- /	1066	1066	-	1066	1066	1066	1066	1066	-	1066	1066	1066	1066	1066	-
2 0: 1 2 1																		

1R - Single Rank 2R - Dual Rank 4R - Quad Rank

on special release as soon as available

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel 3DPC = 3 DIMM per Channel

#### Configuration hints:

- The memory sockets on the systemboard offer a color coding:

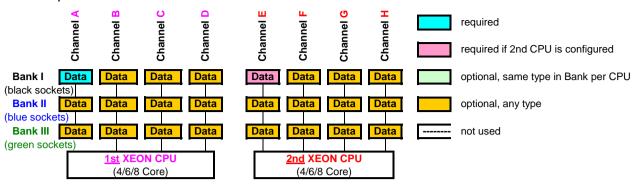
Bank II black sockets
Bank III blue sockets
Bank III green sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)

Bank I on CPU 1/2 up to 4 memory modules connected to Channel A - H on the 1st/2nd CPU up to 4 memory modules connected to Channel A - E on the 1st/2nd CPU up to 4 memory modules connected to Channel A - E on the 1st/2nd CPU up to 4 memory modules connected to Channel A - E on the 1st/2nd CPU (can not be populated by UDIMM or 4R RDIMM memory modules)

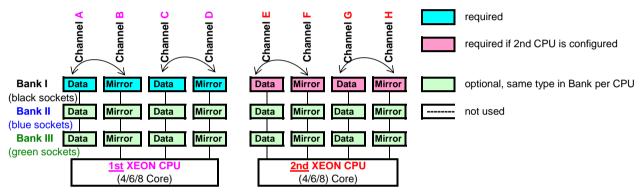
- See below and next page for a detailed descriptions of the memory configuration supported.

## 1. Independent Channel Mode



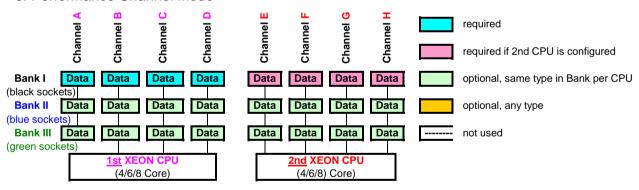
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

### 2. Mirrored Channel Mode



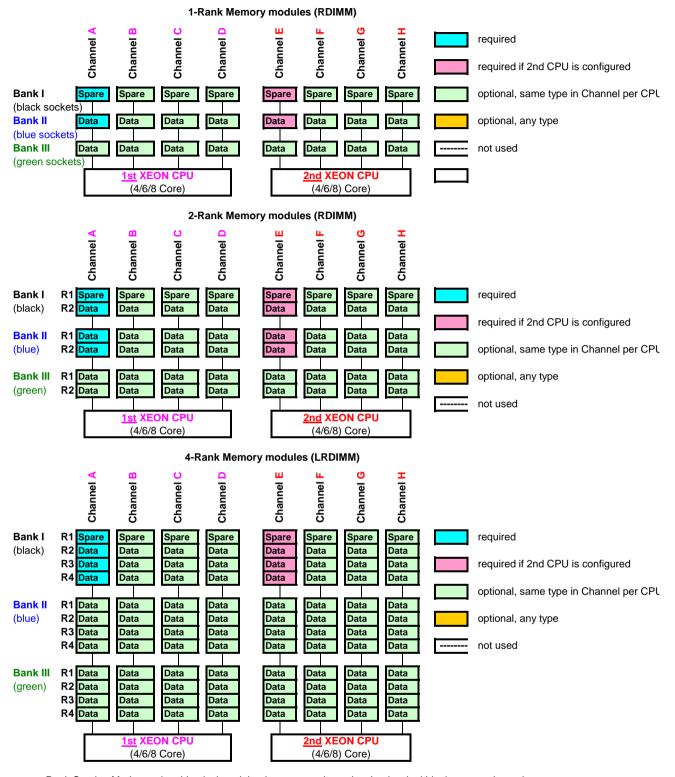
Mirrored Channel Mode requires identical modules on channel A,B, C, D (1st CPU) or channel E, F, G and H (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory If this mode is used, a multiple of 4 identical modules has to be ordered.

## 3. Performance Channel Mode



Performance Channel Mode requires identical modules on all channels of each Bank per CPU. If this mode is used, a multiple of 4 identical modules has to be ordered.

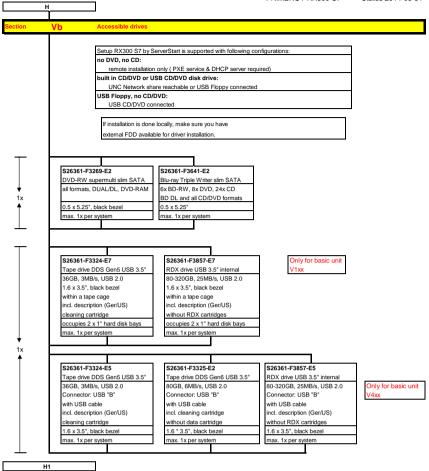
## 4. Rank Sparing Mode

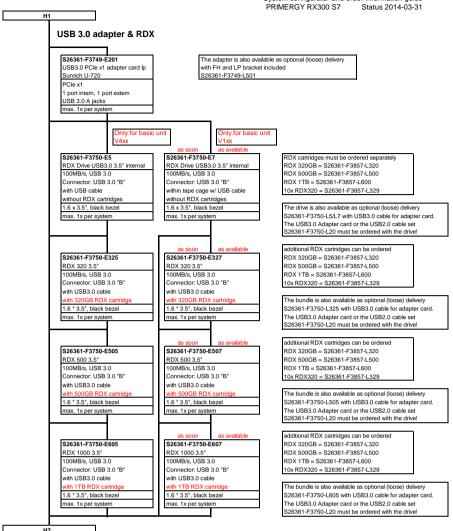


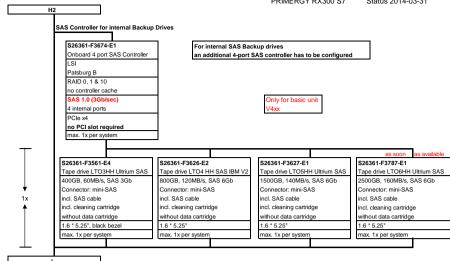
Rank Sparing Mode requires identical modules (same capacity and technology) within the same channel. The available memory for applications will vary depending on configuration. Please refer to the spreadsheet above "Effective Memory capacity with active Rank Sparing Mode". Population rule for Rank sparing mode is to achieve max. available memory, e.g. 6 DIMMs will be spread across two channels, each with 3DPC

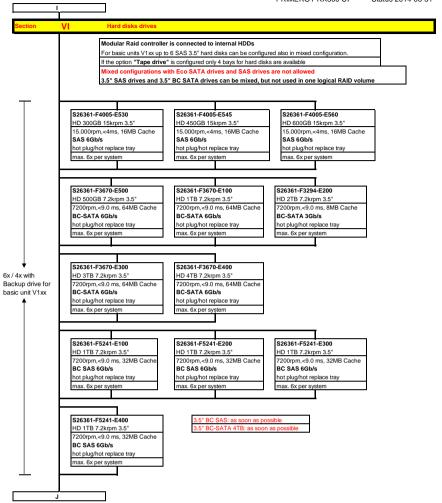


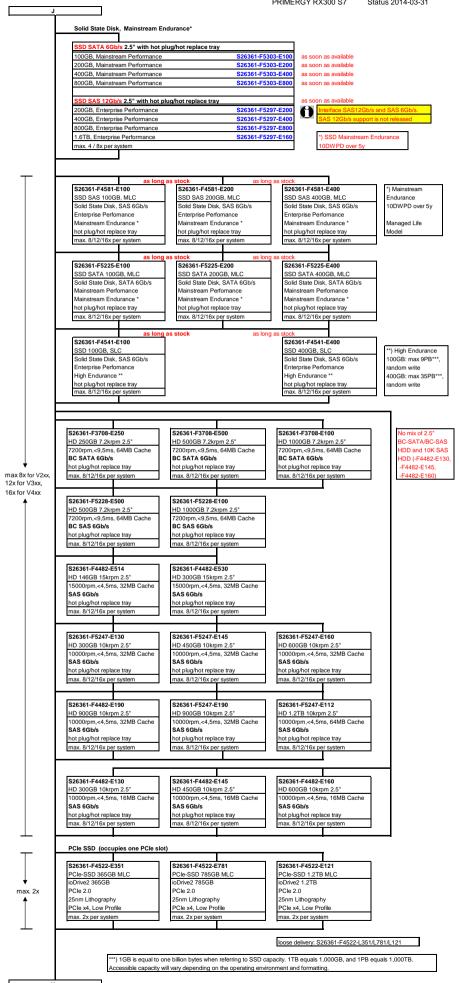
\*) this is the only one noHDD configuration opportunity without needed RAID controller



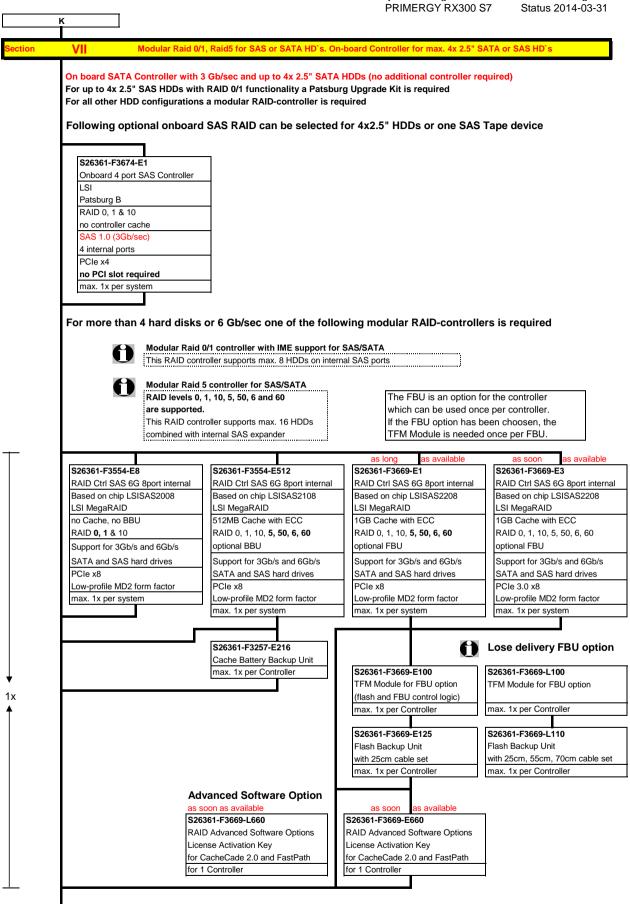


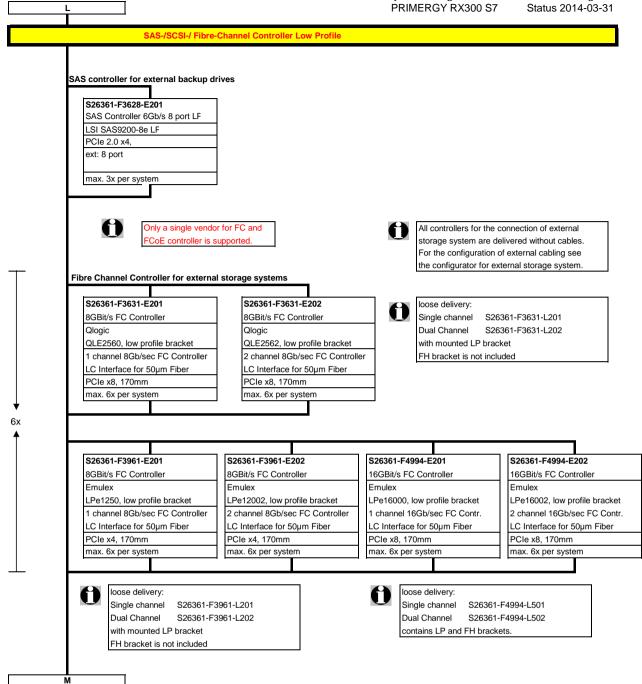


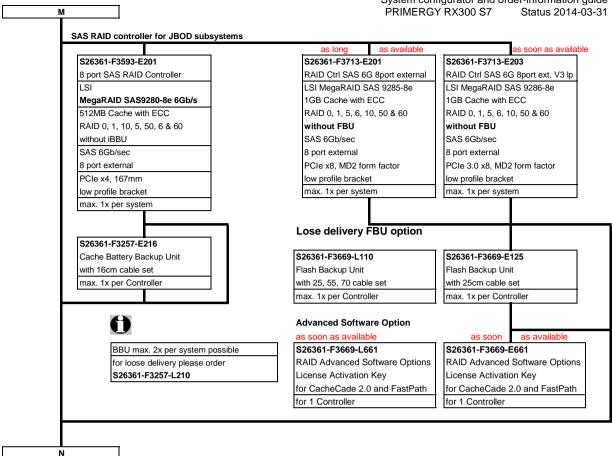


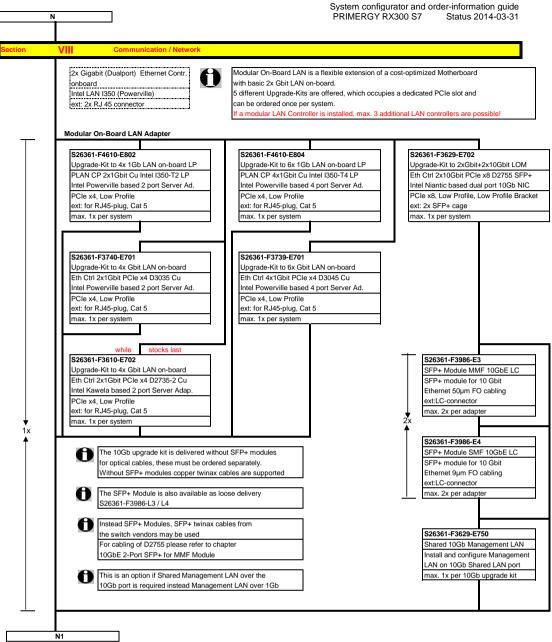


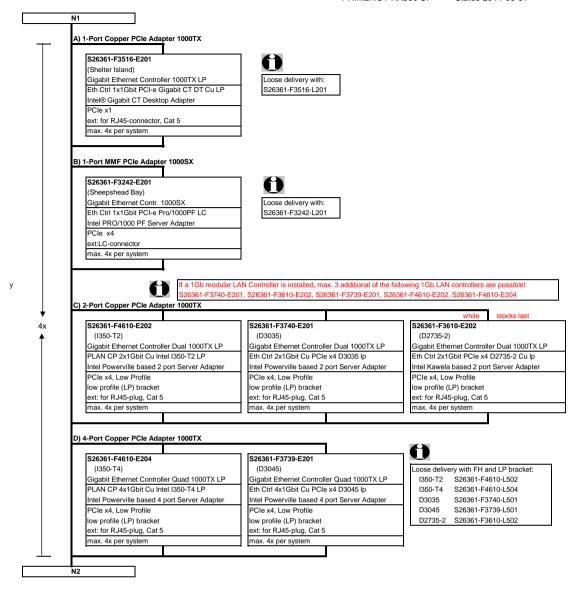
Fujitsu PRIMERGY Server 22 of 31

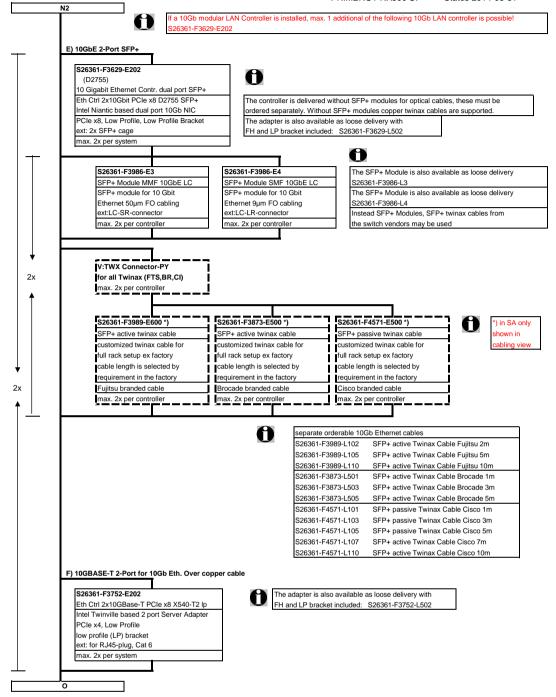


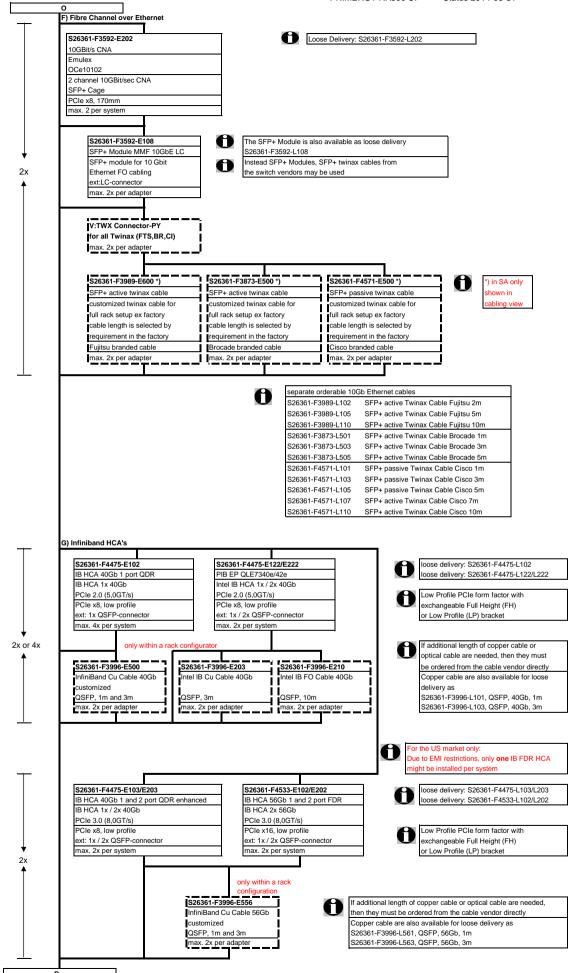


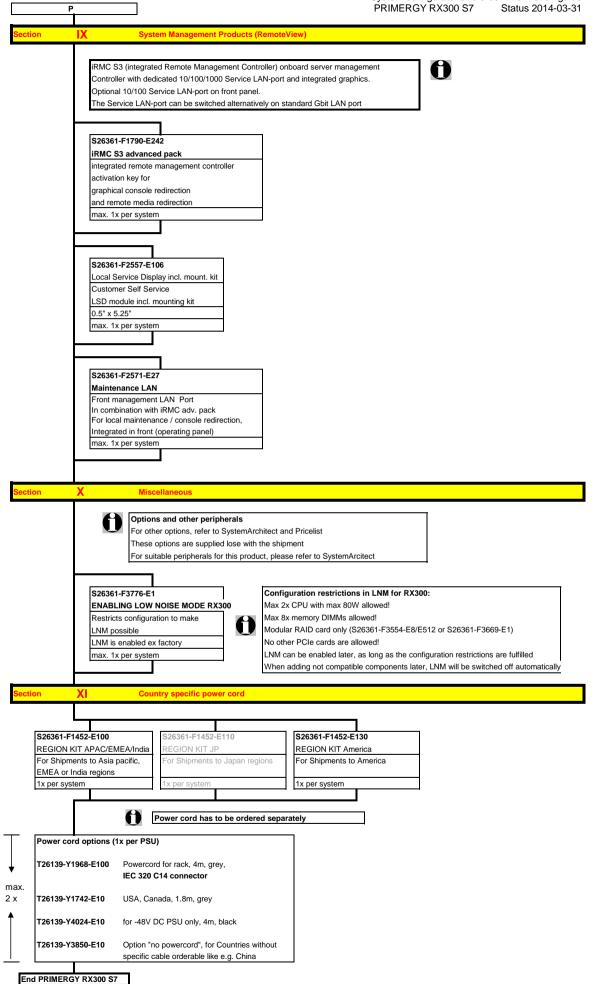












# **Change Report**

Date	Order number	Changes
2013-10-18	optional USB Comps	no longer available
2013-10-16	S26361-F4610-E202 / -E204	added new 1Gb NICs from Intel
2013-09-03	RMK	Cable management is not longer a must component
2013-09-03	S26361-F3787-E1	LTO6 added
2013-05-23	S26361-F3713-E203	RAID Ctrl SAS 6G 8Port ex 1GB LSI V3
2013-05-16	S26361-F3670-E400*	New 3.5" BC-SATA 7.2K HDD 4TB
2013-05-16	S26361-F5241-E*	New 3.5" BC-SAS 7.2K HDD 1/2/3/4TB
2013-05-16	520301-1 3241-L	HDD & SSD description text updated
2013-03-10	S26361-F4522-E351	PCIe-SSD 365GB added
2013-04-25	S26361-F3669-E661/L661	RAID advanced SW options added - for RAID Ctrl SAS 6G 8port external
2013-03-25	S26361-F3669-E660/L660	RAID advanced SW options added - for RAID Ctrl SAS 6G 1GB (D3116C)
2013-03-25	S26361-F3669-E3	RAID Ctrl SAS 6G 1GB (D3116C) added
	S26361-F3750-E325/E505/E60	
2010 00 20	S26361-F3669-L660: S26361-	
2013-03-21	F3669-L661	status changed to "as soon as available"
2013-01-29	S26361-F2735-E145	Add RMK-F1 Standard , tab basic unit
2013-01-17	S26361-F3750-E7	RDX USB3.0 for basic Unit V1xx added
	S26361-F3750-L20	Hint for "RDX Drive USB2.0 cable set" added
2013-01-08	S26361-F5228-E***	New 2.5" BC SAS 7.2K HDD
2013-01-08	S26361-F5247-E***	New 2.5" SAS 10K HDD (mix with BC-SATA supported, sucessor for *F5227*)
2012-12-13	S26361-F3750-E7	RDX USB3.0 for V1xx removed
2012-12-10	S26361-F3694-E3	as soon as available removed
2012-12-07	S26361-F3776-E1	ENABLING LOW NOISE MODE RX300 added
	F3749-E4 and F3750-E4	"as soon as available" removed
2012-11-22	S26361-F3857-E4	"as long as available" added
2012-10-08	S26361-F3749-Exx	Added USB3.0 Adapter
2012-10-08	S26361-F3750-Ex	Added RDX Drive
2012-10-01	S26361-F3986-E4	New SFP+ Module SMF 10GbE LC
2012-10-01	S26361-F3740-E201/E701	New 4-port Intel LAN controller and upgrade kit - as soon as available
2012-10-01	S26361-F3739-E201/E701	New 2-port Intel LAN controller and upgrade kit - as soon as available
2012-09-28	S26361-F4541-E200	EOL: 200GB SSD SAS SLC
2012-07-30	S26361-F2735-L176	Add RMK-F1 LV w/o. CMA adapter (short rail 731mm)
2012-07-25	S26361-F4581-Exxx	Add SSD SAS MLC
	S26361-F5225-Exxx	Add SSD SATA MLC
2012-07-16	S26361-F3857-L160/L169	RDX Cartridge 160GB is EOL => removed
2012-07-13	S26361-F5227-E1*	New order for 2.5" 10K SAS HDD supporting mix with 2.5" BC-SATA HDD
2012-07-13	S26361-F3857-L160/L169	RDX 160GB Cartridge is EOL=> removed
2012-06-12	S26361-F5225-E*00	New order for SATA SSD's
2012-06-05	S26361-F2735-E82	Configuration in asymmetrical racks released
2012-04-23	S26361-F3713-E201	new RAID Controller added
2012-04-20		Memory voltage / frequency spreadsheet, 3DPC at 1.5V only
2012-02-29		First Release
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